



Form Type	Distribute	Version	2.0	Ref	IPC 1752A	Sectionals	Material Info	Subsectionals	D, A
Supplier Information									
Company Name	TE Connectivity	Request Document ID		Contact Name	Penica, John R	Contact Title	Sr Mgr Environmental Engineering		
Company Unique ID	TE Connectivity	Response Date	2015-08-28	Contact Email	jrpenica@te.com				
Contact Phone Number	1-717-592-3266								
Legal Statement									
Supplier Acceptance	true								
Legal Statement									
The information provided in this document is based upon reasonable inquiry of our suppliers. This information is subject to change. This information does not in any way modify existing purchase specifications or existing contractual or other agreements terms between TE Connectivity (or its affiliated companies) and its customers.									
Product									
Manufacturer Item number	1-1634009-0	Amount	256.4	Version	-	Identity			
Manufacturer Item Name	MMCX Str PCB Skt 50Ohm Gold Pl	Weight Uom	mg	Mfr Site		Authority			
Date		UOM	Each						
EUroHS-0508	Product(s) meets EU RoHS requirements by application of the selected exemption(s)								
ChinaRoHS-0508	Product(s) is NOT eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products								
EUREACH-1214	REACH Candidate Substances of Very High Concern ARE NOT Contained in the Product Above the Limits per the Definition within REACH								
Product Disclosure									
Sub-Item/Material/Substance	Level	Name	Substance Category	Substance CAS	Substance Concentration	Quantity	Mass per Unit	UOM	Exemption
Material	1	Nickel Plating				1.0	0.261	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	0.1	1.0	2.61E-4	mg	
Substance	2	Nickel	Nickel	7440-02-0	99.9	1.0	0.26074	mg	
Material	1	Gold Plating				1.0	0.139	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.25	1.0	3.475E-4	mg	
Substance	2	Gold	Supplier	7440-57-5	99.75	1.0	0.13865	mg	
Material	1	Body				1.0	228.6	mg	
Substance	2	Copper	Supplier	7440-50-8	58.8	1.0	134.4168	mg	
Substance	2	Zinc	Supplier	7440-66-6	38.08	1.0	87.05088	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.62	1.0	1.41732	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	2.5	1.0	5.715	mg	6(c) Lead as an alloying element in copper containing up to 4% lead by weight
Material	1	Insulator				1.0	10.5	mg	
Substance	2	Ethene, 1,1,2,2-tetrafluoro-, homopolymer	Supplier	9002-84-0	100.0	1.0	10.5	mg	
Material	1	Contact				1.0	16.9	mg	
Substance	2	Beryllium	Supplier	7440-41-7	1.88	1.0	0.31772	mg	
Substance	2	Copper	Supplier	7440-50-8	97.21	1.0	16.42849	mg	
Substance	2	Contains No Reportable TE5081-2 Substances	Supplier	TE5081-2-1212	0.57	1.0	0.09633	mg	
Substance	2	Lead	Lead/Lead Compounds	7439-92-1	0.34	1.0	0.05746	mg	6(c) Lead as an alloying element in copper containing up to 4% lead by weight